

October 2013

MBR4035PT - MBR4060PT 40 A Schottky Barrier Rectifiers

Features

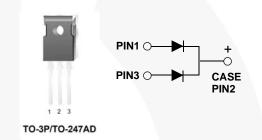
- · Low Power Loss, High Efficiency
- · High Surge Capacity
- Metal Silicon Junction, Majority Carrier Conduction
- · High Current Capacity, Low Forward Voltage Drop
- Guard Ring for Over-Voltage Protection (OVP)

Applications

- Low-Voltage
- · High-Frequency Inverters
- · Free Wheeling
- Polarity Protection

Description

This center-tap Schottky rectifier is optimal for secondary rectification and free-wheeling applications for high-efficiency DC-DC convertor design, which features very low forward voltage drop and low leakage current.



Ordering Information

Part Number	Marking	Package	Packing Method
MBR4035PT	MBR4035PT		
MBR4045PT	MBR4045PT	TO-247 3L	Rail
MBR4050PT	MBR4050PT	10-247 3L	Naii
MBR4060PT	MBR4060PT		

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	MBR 4035PT	MBR 4045PT	MBR 4050PT	MBR 4060PT	Units	
V_{RRM}	Maximum Repetitive Reverse Voltage	35 45 50 60				V	
I _{F(AV)}	Average Rectified Forward Current .375-inch Lead Length at T _A = 125°C		А				
I _{FSM}	Non-Repetitive Peak Forward Surge Current: 8.3 ms Single Half-Sine-Wave	400				А	
T _{STG}	Storage Temperature Range	-65 to +175					
T_J	Operating Junction Temperature Range	-65 to +150					

© 2001 Fairchild Semiconductor Corporation MBR4035PT - MBR4060PT Rev. 1.1.2

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	3.0	W
$R_{ heta JL}$	Thermal Resistance, Junction to Lead	1.2	°C/W

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

					Va	lue			
Symbol	Symbol Parameter			MBR 4035PT	MBR 4045PT	MBR 4050PT	MBR 4060PT	Units	
	I _F = 20 A, T _C = 25°C		0.70		0.72				
\ \ <u>\</u>	V _F Maximum Forward Voltage, per Leg	$I_F = 20 \text{ A}, T_C = 125^{\circ}\text{C}$		0.60		0.62		V	
VF.		I _F = 40 A, T _C = 25°C		0.	80			v	
		$I_F = 40 \text{ A}, T_C = 125^{\circ}\text{C}$		0.	75				
	Maximum Reverse	T _A = 25°C	1.0			mA			
I _R	Current at Rated V _R	T _A = 125°C		100.0					
I _{RRM}	Peak Repetitive Reverse Surge Current, per Leg 2.0 µs Pulse Width, f = 1.0 kHz			2	.0	1	.0	А	

Typical Performance Characteristics

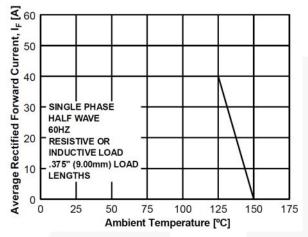


Figure 1. Forward Current Derating Curve

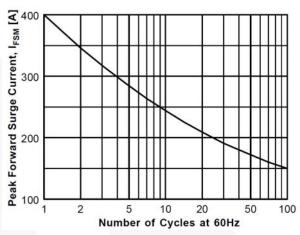


Figure 2. Non-Repetitive Surge Current

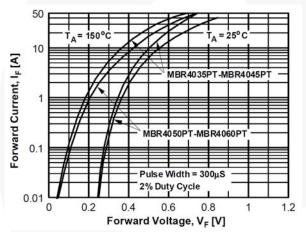


Figure 3. Forward Voltage Characteristics

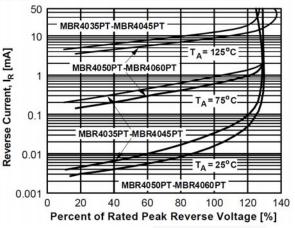


Figure 4. Reverse Current vs. Reverse Voltage

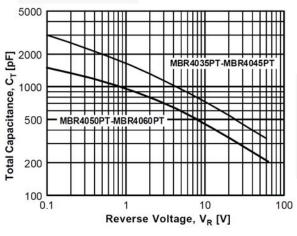


Figure 5. Total Capacitance

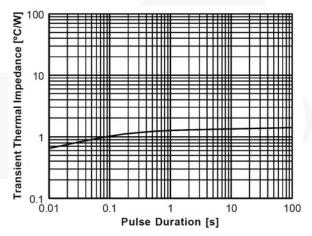
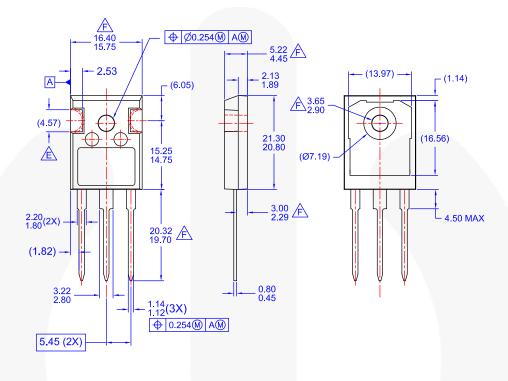


Figure 6. Thermal Impedance Characteristics

Physical Dimensions

TO-247 3L



NOTES: UNLESS OTHERWISE SPECIFIED

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE "E", VARIATION AD
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH. AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5 1994

DOES NOT COMPLY JEDEC STANDARD VALUE.

F. NOTCH MAY BE SQUARE

G. DRAWING FILENAME: MKT-TO247E03 REV02

Figure 7. TO-247, MOLDED, 3 LEADS, JEDEC OPTION AD (ACTIVE)

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Definition of Terms					
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